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July 2014

## FDMA1024NZ Dual N-Channel PowerTrench<sup>®</sup> MOSFET

## **20 V, 5.0 A, 54 m**Ω

#### Features

- Max  $r_{DS(on)}$  = 54 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 5.0 A
- Max  $r_{DS(on)}$  = 66 m $\Omega$  at  $V_{GS}$  = 2.5 V,  $I_D$  = 4.2 A
- Max r<sub>DS(on)</sub> = 82 mΩ at V<sub>GS</sub> = 1.8 V, I<sub>D</sub> = 2.3 A
- Max r<sub>DS(on)</sub> = 114 mΩ at V<sub>GS</sub> = 1.5 V, I<sub>D</sub> = 2.0 A
- HBM ESD protection level = 1.6 kV (Note 3)
- Low profile 0.8 mm maximum in the new package MicroFET 2x2 mm
- RoHS Compliant
- Free from halogenated compounds and antimony oxides



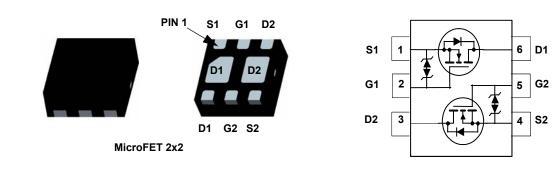
## **General Description**

This device is designed specifically as a single package solution for dual switching requirements in cellular handset and other ultra-portable applications. It features two independent N-Channel MOSFETs with low on-state resistance for minimum conduction losses.

The MicroFET 2X2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.

## Applications

- Baseband Switch
- Loadswitch
- DC-DC Conversion



#### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		20	V
V <sub>GS</sub>	Gate to Source Voltage		±8	V
1	Drain Current -Continuous	(Note 1a)	5.0	^
D	-Pulsed		6.0	— A
P <sub>D</sub>	Power Dissipation	(Note 1a)	1.4	W
	Power Dissipation (Note 1b)		0.7	vv
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	86 (Single Operation)	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	173 (Single Operation)	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1c)	69 (Dual Operation)	C/VV
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1d)	151 (Dual Operation)	

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
024	FDMA1024NZ	MicroFET 2X2	7 "	8 mm	3000 units

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BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D}$ = 250 $\mu$ A, $V_{GS}$ = 0 V	20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		19		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 16 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS}$ = ±8 V, $V_{DS}$ = 0 V			±10	μA
On Char	acteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	0.4	0.7	1.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 250 µA, referenced to 25 °C		-3		mV/°C
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 5.0 A		37	54	
		V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 4.2 A		43	66	
r <sub>DS(on)</sub>	Static Drain to Source On-Resistance	V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 2.3 A		52	82	mΩ
_ = ( )		V <sub>GS</sub> = 1.5 V, I <sub>D</sub> = 2.0 A		67	114	
						1
		$V_{GS}$ = 4.5 V, $I_{D}$ = 5.0 A, $T_{J}$ = 125 °C		51	75	
9 <sub>FS</sub>	Forward Transconductance	$V_{GS} = 4.5 \text{ V}, I_D = 5.0 \text{ A}, T_J = 125 \text{ °C}$ $V_{DD} = 5 \text{ V}, I_D = 5.0 \text{ A}$		51 16	75	S
Dynamio	Characteristics			16		
<b>Dynamio</b> C <sub>iss</sub>	Characteristics			16 375	500	pF
Dynamic C <sub>iss</sub> C <sub>oss</sub>	Characteristics Input Capacitance Output Capacitance	V <sub>DD</sub> = 5 V, I <sub>D</sub> = 5.0 A		16 375 70	500 95	pF pF
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Characteristics	$V_{DD} = 5 V, I_D = 5.0 A$ $V_{DS} = 10 V, V_{GS} = 0 V,$		16 375	500	pF
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>G</sub>	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	$V_{DD} = 5 V, I_D = 5.0 A$ - $V_{DS} = 10 V, V_{GS} = 0 V,$ - f = 1 MHz		16 375 70 40	500 95	pF pF pF
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>G</sub> Switchir	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DD} = 5 V, I_D = 5.0 A$ - $V_{DS} = 10 V, V_{GS} = 0 V,$ - f = 1 MHz		16 375 70 40	500 95	pF pF pF
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>G</sub> Switchir	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Ing Characteristics	$V_{DD} = 5 V, I_D = 5.0 A$ $V_{DS} = 10 V, V_{GS} = 0 V,$ f = 1 MHz f = 1 MHz		16 375 70 40 4.3	500 95 65	pF pF pF Ω
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>G</sub> Switchir t <sub>d(on)</sub>	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance  Characteristics Turn-On Delay Time	$V_{DD} = 5 V, I_D = 5.0 A$ - $V_{DS} = 10 V, V_{GS} = 0 V,$ - f = 1 MHz		16 375 70 40 4.3 5.3	500 95 65 11	pF pF pF Ω ns
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>G</sub> Switchir	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance  D Characteristics Turn-On Delay Time Rise Time	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 5.0 \text{ A}$ $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $f = 1 \text{ MHz}$ $V_{DD} = 10 \text{ V}, \text{ I}_{D} = 5.0 \text{ A}$		16 375 70 40 4.3 5.3 2.2	500 95 65 11 10	pF pF pF Ω ns
Dynamic $C_{iss}$ $C_{oss}$ $C_{rss}$ $R_G$ Switchir $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	Characteristics     Input Capacitance     Output Capacitance     Reverse Transfer Capacitance     Gate Resistance      Gate Resistance      Turn-On Delay Time     Rise Time     Turn-Off Delay Time	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 5.0 \text{ A}$ $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $f = 1 \text{ MHz}$ $V_{DD} = 10 \text{ V}, \text{ I}_{D} = 5.0 \text{ A}$ $V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		16 375 70 40 4.3 5.3 2.2 18	500 95 65 11 10 33	pF pF pF Ω ns ns
Dynamic $C_{iss}$ $C_{oss}$ $C_{rss}$ $R_G$ Switchir $t_{d(on)}$ $t_r$ $t_{d(off)}$	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance  C Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 5.0 \text{ A}$ $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $f = 1 \text{ MHz}$ $V_{DD} = 10 \text{ V}, \text{ I}_{D} = 5.0 \text{ A}$		16 375 70 40 4.3 5.3 2.2 18 2.3	500 95 65 11 10 33 10	pF pF pF Ω ns ns ns ns

**Test Conditions** 

Min

Тур

Max

Units

**Electrical Characteristics** T<sub>J</sub> = 25 °C unless otherwise noted

Parameter

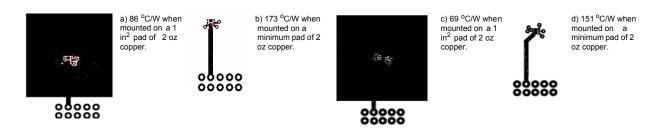
Symbol

I <sub>S</sub>	Maximum Continuous Source-Drain Diode Forward Current				1.1	А
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 1.1 A	(Note 2)	0.7	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	L = 5.0.0 di/dt = 100.0/	19	35	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> = 5.0 A, di/dt = 100 A/μs		5	10	nC

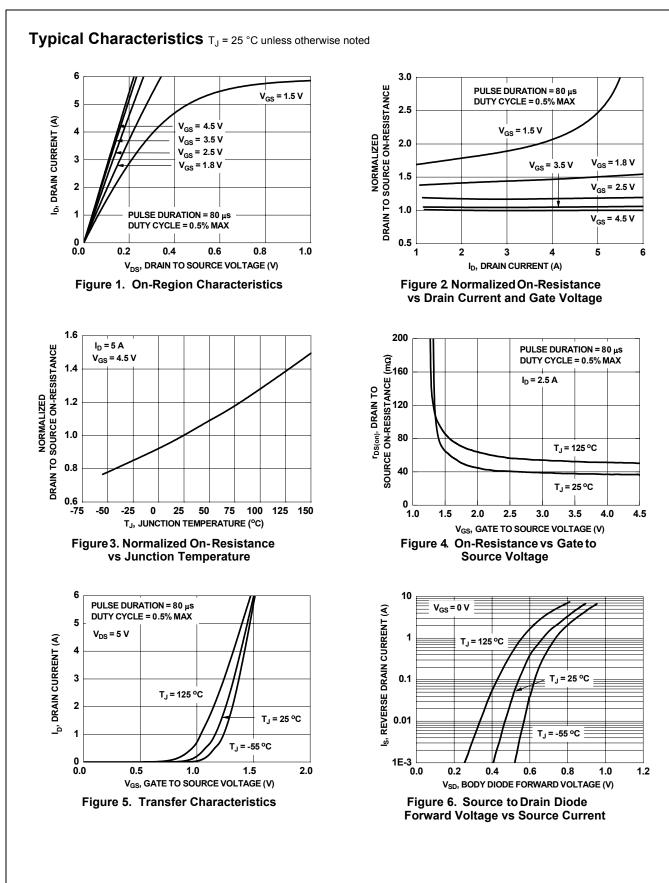


#### Notes:

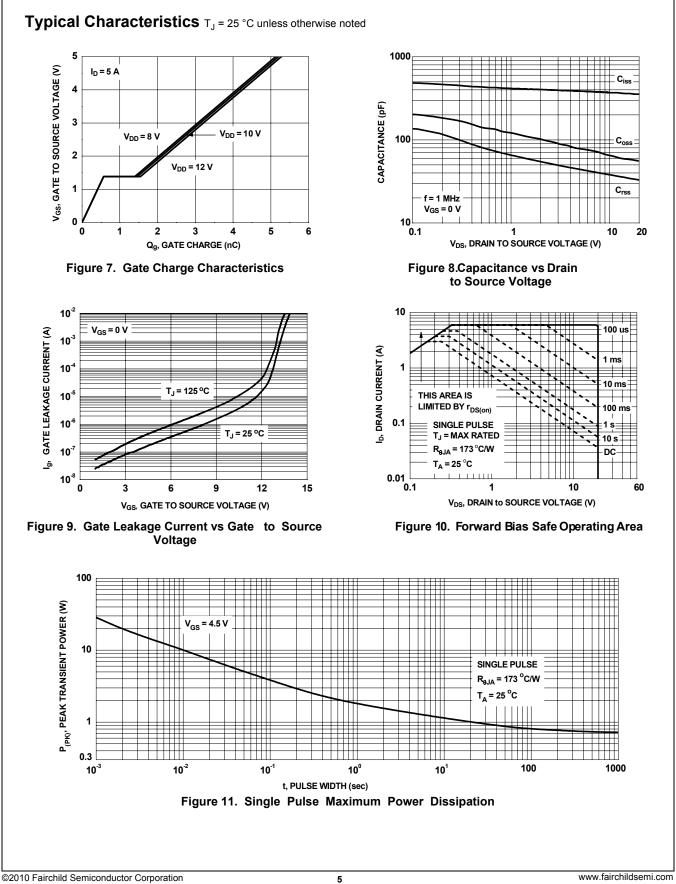
- R<sub>BJA</sub> is determined with the device mounted on a 1 in<sup>2</sup> oz. copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>BJC</sub> is guaranteed by design while R<sub>BJA</sub> is determined by the user's board design.
   (a) R<sub>BJA</sub> = 86 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For single operation.
  - (b)  $R_{\theta JA} = 173 \text{ °C/W}$  when mounted on a minimum pad of 2 oz copper. For single operation.
  - (c)  $R_{\theta JA} = 69 \text{ }^{\circ}\text{C/W}$  when mounted on a 1 in<sup>2</sup> pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For dual operation.
  - (d)  $R_{0JA}$  = 151 °C/W when mounted on a minimum pad of 2 oz copper. For dual operation.



- 2. Pulse Test : Pulse Width < 300 us, Duty Cycle < 2.0 %
- 3: The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

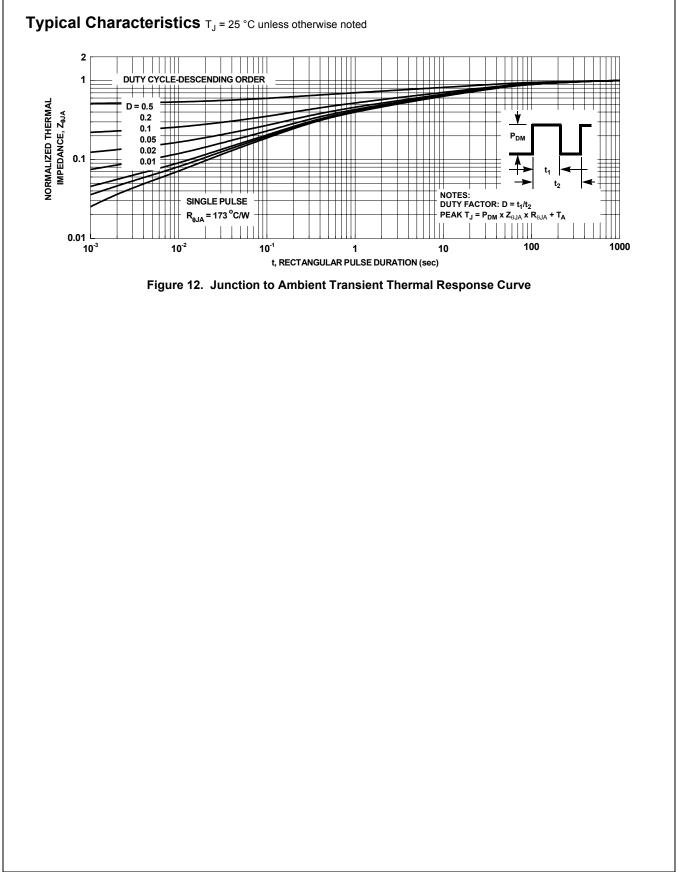


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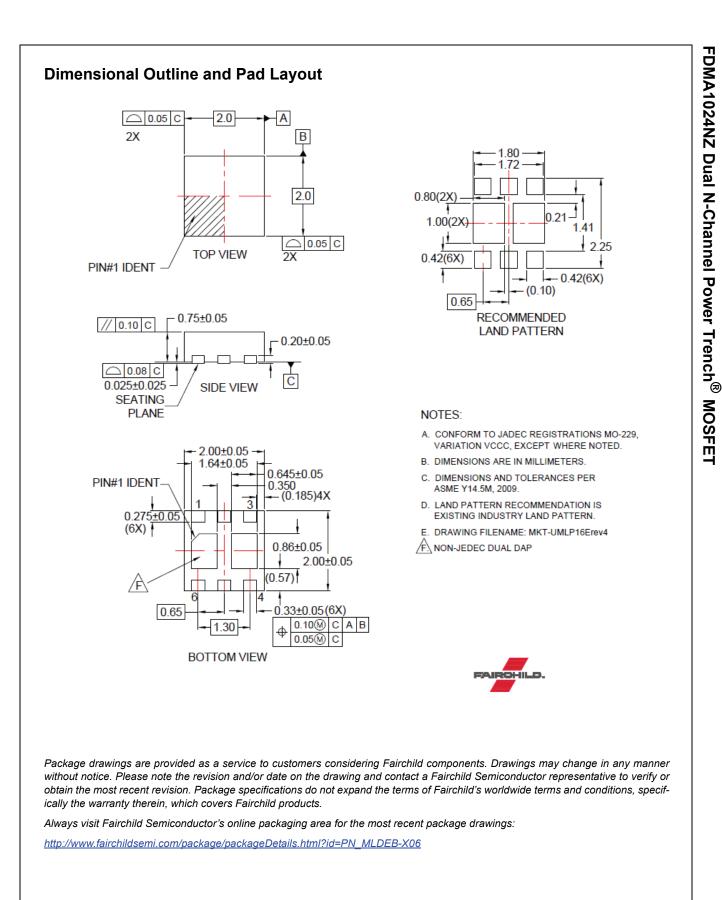


FDMA1024NZ Dual N-Channel Power Trench<sup>®</sup> MOSFET

FDMA1024NZ Rev.B5



FDMA1024NZ Dual N-Channel Power Trench<sup>®</sup> MOSFET



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Not In Production

Obsolete

Datasheet contains specifications on a product that is discontinued by Fairchild

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Rev. 168

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